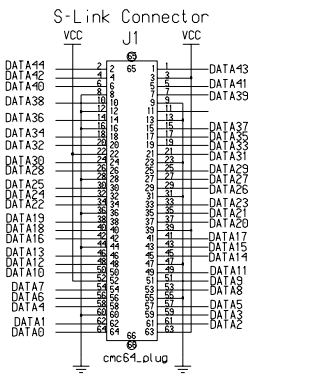
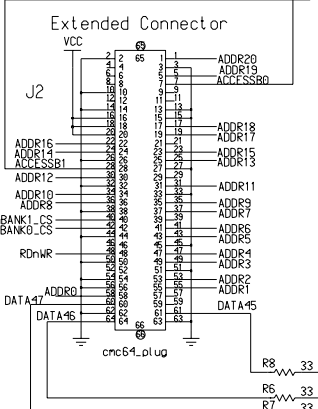


LED DISPLAY TABLE

	LED1	LED2	LED3	LED4	LED5
POWER ON	ON	ON	ON	ON	ON
POWER OFF	OFF	OFF	OFF	OFF	OFF
BANK0_WRITE	ON	OFF	ON	OFF	OFF
BANK0_READ	OFF	ON	ON	OFF	OFF
BANK0_STANDBY	X	X	X	OFF	X
BANK1_WRITE	ON	OFF	OFF	ON	OFF
BANK1_READ	OFF	ON	OFF	ON	OFF
BANK1_STANDBY	X	X	X	X	OFF



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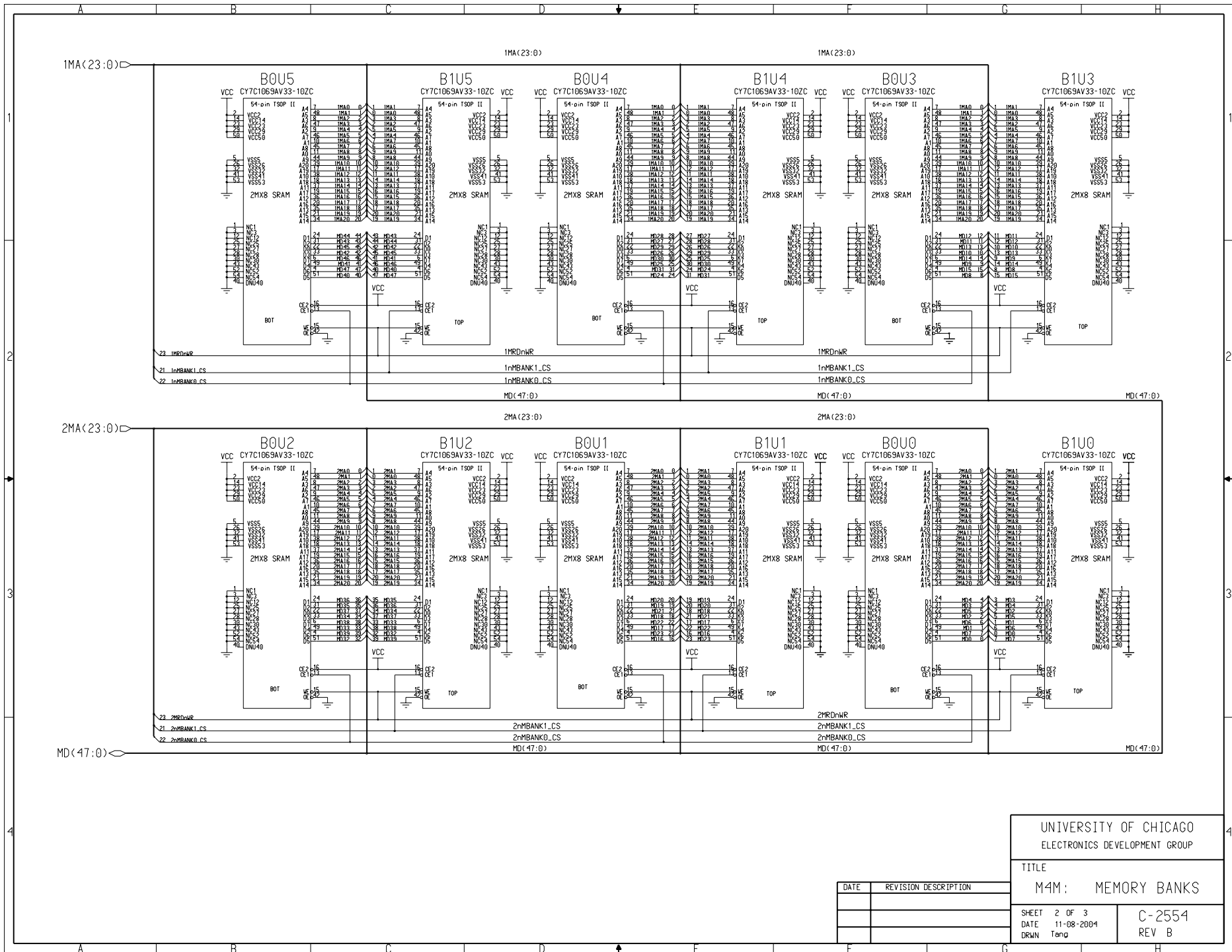
TITLE  
M4M: ADDRESS & DATA BUFFERS

SHEET 1 OF 3  
DATE 11-08-2004  
DRWN Temp

C-2554  
REV B

DATE	REVISION	DESCRIPTION

EDG Schematics #: C2554  
EDG PCB Specification #: A2555  
EDG Assembly Drawing #: B2556



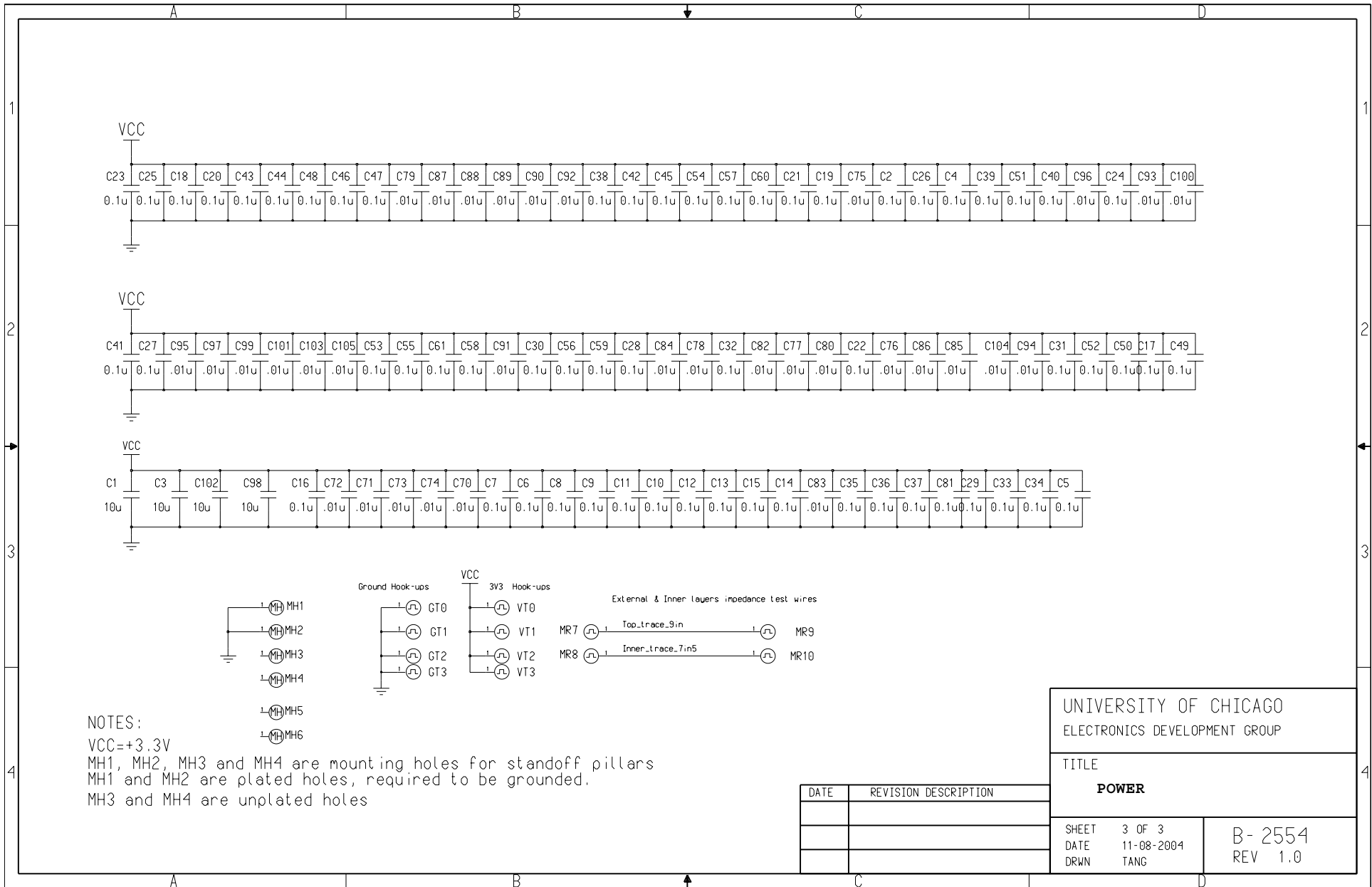
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TITLE  
M4M: MEMORY BANKS

DATE	REVISION	DESCRIPTION

SHEET 2 OF 3  
DATE 11-08-2004  
DRWN Temp

C-2554  
REV B



NOTES:  
VCC=+3.3V  
MH1, MH2, MH3 and MH4 are mounting holes for standoff pillars  
MH1 and MH2 are plated holes, required to be grounded.  
MH3 and MH4 are unplated holes

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TITLE <b>POWER</b>	
SHEET 3 OF 3 DATE 11-08-2004 DRWN TANG	B-2554 REV 1.0

DATE	REVISION DESCRIPTION